ASSOCIATION CONNECTING ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES® international and Pa	PC. Bannockl	burn. Illinois. A	ll rights reserved untions.	under both	This docume level parts, t	ent is a declarati he declaration e	on of the su	ibstances v s all lower	within the manufact level materials for	urer listed which the	item. Note: manufactur	if the item is an as er has engineering	ssembly with low responsibility.	
				Form Type Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information					ation				
Supplier Information														
Company name* Com			Company unique ID			Unique ID Authority				Respo	Response Date*			
nsemi									2024-05-21					
Contact Name	tact Name Title - Contact					Phone - Contact*				Email	Email - Contact*			
Product-Env-Stewards Product Envir			iro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Authorized Representative* Title - Repr			resentative			Phone - Representative*				Email	Email - Representative*			
Product-Env-Stewards Pr			Product Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Requester Item Number	Mfr Iten	n Number	Mfr Item Name			Effective Date	Version	M	Manufacturing Site		Weight*	UOM	Unit Type	
	NRVBS	VRVBSS29FA 90V 2A Schottky R		Rectif		2024-05-21		T	TSCBE		19.0	mg	Each	
Ianufacturing Proccess Informa	tion		·											
Terminal Plating / Grid Array M	aterial T	ial Terminal Base Alloy J-S			L Rating	Peak Process Body Temperature Ma			e Max Time at Pea	k Tempera	ature Num	nber of Reflow Cy	cles	
Matte Tin (Sn) - annealed CU Alloy			1		260		С	30	seco	onds 3				
omments														
vel 1 - maximum time at peak temperat	ure during so	dering is 10-3	0 seconds											
or more information regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		mium (Cr6+), Polybrominated Biphenyls (Pl		dmium and quantity limit of 0.1% by mass (10 minated Diphenyl Ethers (PBDE), and Bis(2-et	
cadmium, hexavalentchromium, polybromina contains a RoHS restricted substance inexces encompass all such components. Supplier cer as of the date that Supplier completes this for Company acknowledges that Supplier may h independently verified information provided certification in this paragraph. If the Company	ated biphenyls and/or polybrominated dip s of an applicable quantity limit, please in iffies that it gathered the information it pr m.Supplier acknowledges that Company ave relied on informationprovided by oth by others, Supplier agrees that, at a minir and the Supplier enter into a written agr esource of the Supplier's liability and the	henyl ethers (each a "RoHS restricted substa ndicate below which, if any, RoHS exemption ovides in this form using appropriate methoo will rely on this certification in determining ers in completing this form, and that Supplie num, itssuppliers have provided certification eement with respect to the identified part, the Company's remedies for issues that arise reg	nce") in exco n you believe ls to ensure i the compliar r may not ha s regarding t terms and co	e may apply. If the part is an assembly with low s accuracy and that such information is true an ce of its products with European Union member de independently verified such information. Ho neir contributions to the part, and those certifica	ove. If a homogeneous material within the part er level components, the declaration shall d correct to the best of its knowledge and belief, er state laws that implement the RoHS Directive. wever, in situations where Supplier has not ations are at least as comprehensive as the anty rights and/or remedies provided as part of
RoHS Declaration * 4 - Item(	s) does not contain RoHS restricted subst	ances per the definition above except for sele	ected exempt	ions Supplier Acceptance	* Accepted
Exemption: 7a: Lead in high melting temp	erature type solders (i.e. lead based sol	der alloys containing 85% by weight or m	ore lead).		
Exemption List Version	EL-2011/534/EU				
Declaration Signature					
Instructions: Complete all of the required Requester) and click on Submit Form to h			e drop-dowi	a. This will display the signature area. Digita	lly sign the declaration (if required by the
Supplier Digital Signature	astislav Drska	Le			

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

sigma range of distribution unless otherwise noted).									
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure	
Die	0.8113	mg	Supplier	Titanium (Ti)	7440-32-6		0.0012	mg	
			Supplier	Silver (Ag)	7440-22-4		0.0302	mg	
			Supplier	Silicon (Si)	7440-21-3		0.7724	mg	
			В	Nickel (Ni)	7440-02-0		0.0075	mg	
Die Attach Solder	1.67086	mg	Supplier	Silver (Ag)	7440-22-4		0.0418	mg	
			А	Lead (Pb)	7439-92-1	7a	1.5455	mg	
			Supplier	Tin (Sn)	7440-31-5		0.0835	mg	
Lead Frame	7.25648	mg	Supplier	Iron (Fe)	7439-89-6		0.0073	mg	
			Supplier	Copper (Cu)	7440-50-8		7.247	mg	
			Supplier	Phosphorus (P)	7723-14-0		0.0022	mg	
Mold Compound-Black	9.07041	mg		Metal Hydroxide	proprietary data		0.4535	mg	
			Supplier	Carbon Black (C)	1333-86-4		0.0907	mg	
			Supplier	Fused Silica (SiO2)	60676-86-0		6.8028	mg	
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		0.907	mg	
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.8163	mg	
Plating	0.19095	mg	Supplier	Tin (Sn)	7440-31-5		0.191	mg	